

General Description

(1) Operating principles of the Hall device

The Hall device is an electro-magnetic conversion device which converts magnetic flux density into voltage, and is used as a magnetic sensor. When an electric current I_c is passed through a semiconductor chip and a perpendicular magnetic field (magnetic flux density B) is introduced, voltage V_H is generated perpendicular to both electric current I_c and magnetic flux density B . This phenomenon is called the Hall effect, after the American researcher E.H.Hall, who discovered it in 1879.

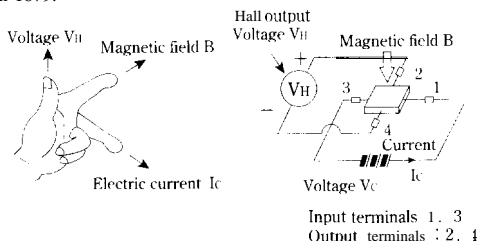


Fig. 1 Principles and structure of the Hall device

Voltage V_H is called the Hall voltage, and is derived from the following equation :

$$V_H = K_H \cdot I_C \cdot B \quad (1) \text{ (for constant-current operation)}$$

$$= K^* \cdot V_C \cdot B \quad (2) \text{ (for constant-voltage operation)}$$

Here K_H is called the Hall sensitivity, which is determined according to the semiconductor material used. It is usually expressed in units of $mV/mA100 \text{ mT}$. based on an input current of 1 mA and a magnetic flux density of 100 mT (milliteslas). K^* is derived from the equation $K^* = K_H/R_d$ (where R_d is the internal resistance of the device).

(2) Comparison of Hall device materials

The characteristics of Hall devices are determined by their material and shape, and vary according to two material constants: electron mobility μ and the energy band gap E_g . The larger the electron mobility μ is, the higher the sensitivity becomes. The larger the energy band gap is, the better the temperature characteristics of the Hall device are. Values for μ and E_g for the main materials used are shown in Table 1 below.

Table 1: Comparison of materials used in Hall devices

	Electron mobility($cm^2/V \text{ sec}$)	Energy band gap(E_g)
Si	1 900	1.12
GaAs	8 800	1.43
InSb	78 000	0.17
InAs	33 000	0.35

(Estimated values)

The characteristics of Hall devices made with each of the above materials is as follows.

- Si: Although temperature characteristics are excellent, sensitivity is low and imbalance voltage V_{H0} (voltage generated without application of a magnetic field) is large. Presently, silicon Hall devices are used mainly as Si Hall ICS with an amplifier or other devices integrated on a single chip, rather than as simple Hall devices.
- InSb This material features high sensitivity due to high electron mobility, but the small band gap causes considerable temperature drift.
- InAs With less electron mobility than InSb, this material has lower sensitivity, but because the band gap is greater than that of InSb, temperature drift is smaller. This material is used in Hall probes for measuring magnetic fields due to its good linearity with respect to magnetic fields.
- GaAs GaAs's large band gap produces the least temperature drift among all the materials shown in Table 1. While its electron mobility is smaller than that of InSb, lowering its sensitivity. GaAs's good control characteristics allow high sensitivity to be obtained through the same fine processing used in GaAs ICS.

(3) Chip structure and the features of Sharp Hall devices

In Sharp Hall devices, the active layer is formed by direct ion injection into a semi-insulated GaAs substrate. This process has the same excellent control properties as the GaAs IC fabrication process, making fine processing easy. Sharp Hall devices therefore feature low dispersion of characteristics as well as high sensitivity

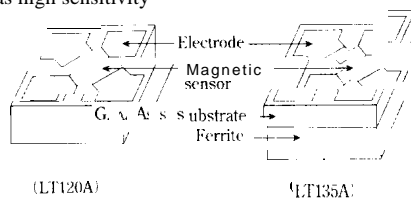


Fig. 2 Chip structure

(4) Features of Sharp Hall devices

Temperature coefficient of the Hall voltage is small.

(see Table 2-1)

Linearity of the Hall voltage is good. (see Table 2-2)

. Temperature coefficient of the input resistance is small.

(see Table 2-3)

[dispersion of characteristics is low. (see Table 2-4).

<Features of the high-sensitivity LT135A >

The Sharp high-sensitivity LT135A Hall device incorporates

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ferrite for magnetic flux convergence and optimizes active layer carrier density to achieve a Hall device with especially high sensitivity and precision even for a GaAs device (for details see data pages 16 and 17).

- No-load Hall voltage TYP. 240 mV (6 V, 100 mT)
- Controls temperature drift of the imbalance voltage V_{HO} over a wide range.

Max. temperature drift ± 5 mV
(-20°C to $+25^{\circ}\text{C}$, $+25^{\circ}\text{C}$ to $+125^{\circ}\text{C}$)

[It is not specified for commercially available GaAs Hall devices.]

Linearity range (recommended operating temperature range) is increased for easier use.

Within the ranges of -20°C to $+25^{\circ}\text{C}$ and $+25^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ (compared with the range for previous Sharp products of 0 to 80°C)

Temperature coefficient of Hall voltage TYP. $-0.03\%/^{\circ}\text{C}$.

Temperature coefficient of input resistance TYP. $0.2\%/^{\circ}\text{C}$.

[The temperature range for commercially available GaAs Hall devices is unknown.]

(5) Hall ICs

In addition to the GaAs Hall devices described above, Sharp manufactures two types of "Hall IC," which combine a GaAs Hall device and a silicon IC within a single device.

One of these devices can convert amplifier output to a digital signal via a Schmidt circuit and connects directly to a TTL or CMOS IC. It is therefore used in noncontact switches (LT230A/253A/251A/260A/261A/262A). The other device, the fan motor Hall IC (LT202A), is commonly used to drive the brushless DC fan motors of cooling systems for office automation equipment such as personal computers, and consumer electronics products.

There are two types of Hall ICs for noncontact switch, classified according to their method of utilizing the magnetic field:

(a) Those which utilize changes in the strength of a unidirectional magnetic field (south pole) to drive the IC (unidirectional field type)

(b) Those which create an alternating magnetic field by rotating a disc magnet with alternating contacts between north and south poles (alternating field type)

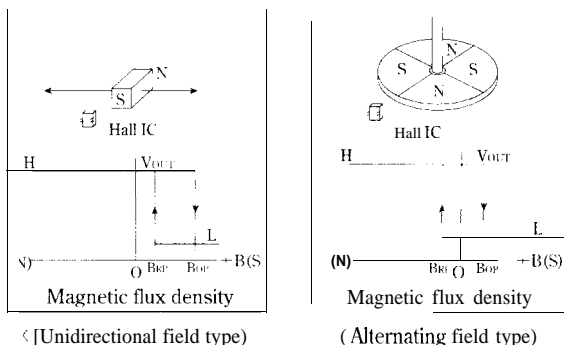
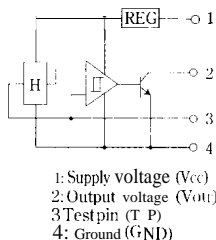


Fig. 3 Contactless switch Hall ICs
(BRP: release point, BOP: operating point)

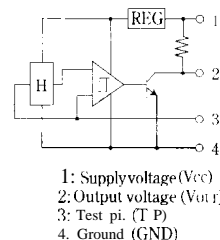
Electrical output is as shown in Fig. 3. Output is produced in response to variations in magnetic flux density. The unidirectional field type and the alternating field type are each available in an open collector type and a direct-coupled (built-in pull-up resistance) type TTL.

Using its proprietary process and assembly technology, Sharp manufactures compact-size Hall ICs (2.9 x 1.56 x 1.1 mm), with high sensitivity (operating point: 30 mT max.) and wide temperature characteristics (-20°C to $+125^{\circ}\text{C}$). In particular, to conform to Electrical Industry Association of Japan (EIAJ) standards for chip component dimensions, the chip has a compact design and can be mounted automatically.

< Open-collector type >



< Direct-coupled type TTL >



(Notice: LT262A does not have a built-in REG.)

Fig. 4 Block diagram of Hall ICs for contactless switches

Table 2: Comparison of Sharp GaAs Hall devices and commercially available InSb Hall devices

	Sharp GaAs Hall device (model No. LT120A)	Commercially available InSb Hall devices
1 Temperature coefficient of Hall voltage	MAX. $-0.04\%/^{\circ}\text{C}$	MAX. $-2\%/^{\circ}\text{C}$
2 Hall voltage linearity	MAX. 0.3%	MAX. 5%
3 Temperature coefficient of input resistance	MAX. $0.2\%/^{\circ}\text{C}$	MAX. $-2\%/^{\circ}\text{C}$
4 Input resistance	650 to 950 Ω	240 ~ 550 Ω

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(6) Application fields for Hall devices

Because of their excellent temperature characteristics and Hall voltage linearity, these GaAs Hall devices can be applied not only in brushless DC motors using pulse output, but also in high-precision, low-rotation-speed brushless DC motors using linear (sine wave) output, and in ammeters and displacement gages.

Table 3: The Hall device market

Field of Application	Equipment	Application
A/V equipment	VCRs, Camcorders, DAT, Video disc players, Cassette recorders	Brushless DC motors, FG detections, reel-rotation detections
OA equipment	FDD, CD-ROM drives, printers, laser scanners	Brushless DC motors, index detections, paper-feed quantify detections
Measuring equipment	Water supply meters, ammeters, wattmeters, fluxmeters, displacement gages	Rotation detections, electric current detectors, magnetic flux density detections
Consumer electronics	Inverter air-conditioners	Rotation detections
Other	Automobiles, sewing machines	Engine rotation detections, position detections, displacement detections

1 Brushless DC motors

Brushless DC motors require no contact point because they use a Hall device to detect the rotor position. This reduces noise and extends the operating life of the equipment. Also, by synchronizing with an external control signal, the rotation speed can be accurately controlled.

Brushless DC motors are available in two types: axial [Fig. 5 (b)] and radial [Fig. 5 (a)]. The Hall device in the axial type can be placed inside the magnetic circuit, enabling the use of low-sensitivity Hall devices. In the radial type, however, the Hall device is placed outside the magnetic circuit, requiring a high-sensitivity Hall device.

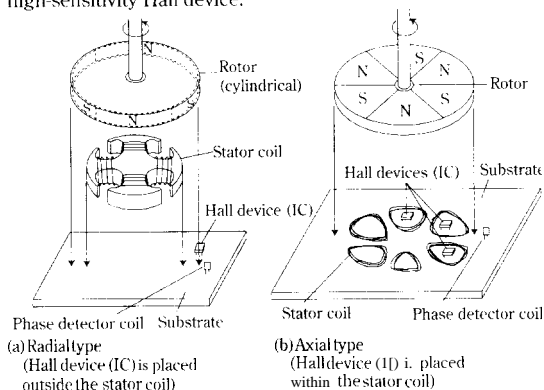
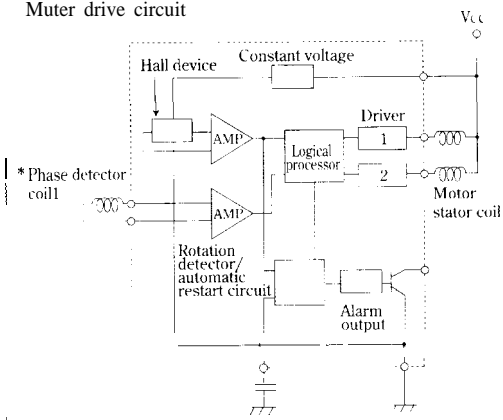


Fig. 5 Structure of brushless DC motors

Moter drive circuit



*1 Phase detector coil

This coil detects the phase of the magnetic pole and cuts any electric current which is not contributing to rotation. This increases the efficiency of motor rotation.

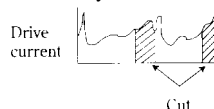
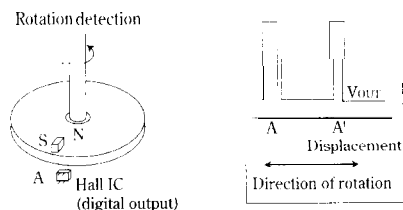


Fig. 6 High-efficiency motor drive method (the area within the dotted line represents the Sharp LT202A)

2 Rotation detection

The Hall device detects rotation by detecting the changes in magnetic flux occurring during rotation of a multipolar magnet. Using the LT253A, magnets polarized to as little as 0.5 mm can be detected



Digital output circuit

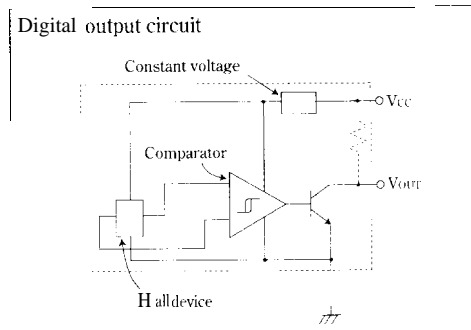


Fig. 7 Method of detecting rotation (the area within the dotted line represents the Sharp contactless switch Hall IC)

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Displacement detection

As Fig. 8 shows, when a Hall device is placed on a bar magnet, the shift in the magnet causes the output voltage shown in Fig. 9 to occur in the Hall device. The displacement can be detected by using magnet displacement and the linear area of Hall voltage.

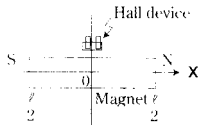


Fig. 8
Displacement detection

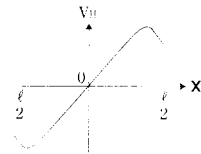
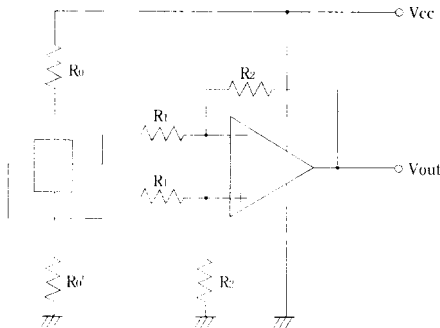


Fig. 9
Example of output of displacement detection

(7) Application circuit for the Hall device

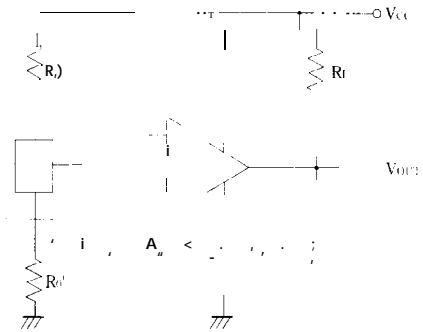


$$V_{out} = \frac{R_2}{R_1} V_H \quad (V_H = \text{Hall voltage})$$

Resistors R_0 and R_0' are used to adjust the impressed current or voltage of the Hall device. If the impressed current or voltage is below the rated voltage, they are not required.

Fig. 10 Diagram of circuit with linear-amplified Hall device

Hall devices (LT120A, LT135A, LT140A) Comparator (IR9393)



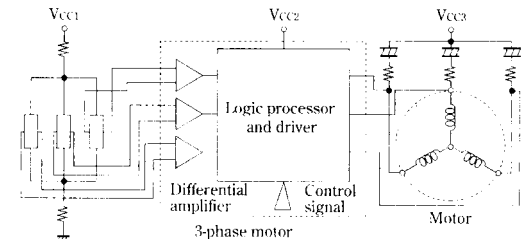
R_0 : Pull-up resistor

$$V_{TH} = \frac{R_0' + R_1}{R_0' + R_1 + R_2} V_{CC}$$

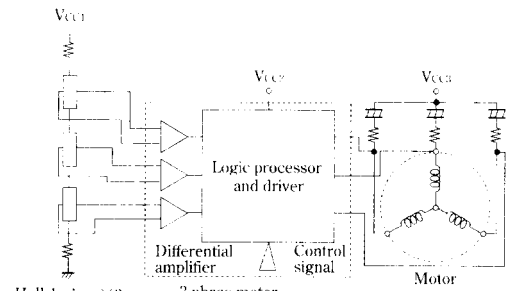
V_{TH} : Hysteresis width

R_2 : Resistance between terminals 3 and 4 of the Hall devices
Resistors R_0 and R_0' are used to adjust the impressed current or impressed voltage of the Hall device. If the impressed current or voltage is below the rated voltage, they are not necessary.

Fig. 11 Diagram of circuit receiving switching output from the Hall device



(Parallel type)

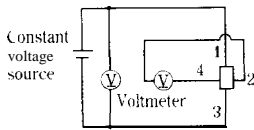


{Serial type}

Fig. 12 Examples of Hall motor circuit applications

(8) Measurement circuits

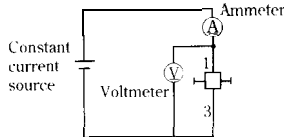
(a) Imbalance voltage V_{HO} , no-load Hall voltage V_H



Terminal connections
 1: Input + 3: Input -
 2: Output + 4: Output -

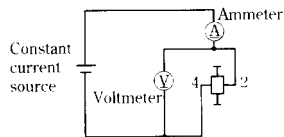
$V_H = V_M - V_{HO}$
 V_M : Output voltage measurement value from specific magnetic field
 V_{HO} : Voltage measurement value when no magnetic field is present

(b) Input resistance



$R_{IN} = V_M / I_M$
 V_M : Voltage measurement value
 I_M : Specified current

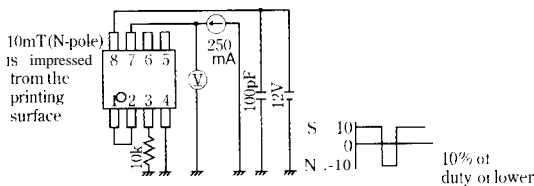
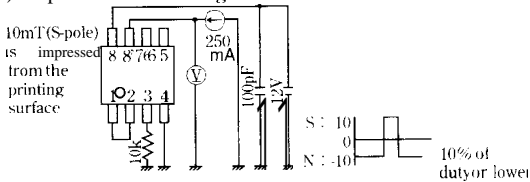
(c) Output resistance



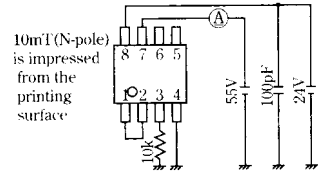
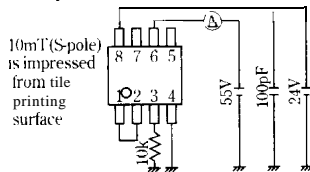
$R_{OUT} = V_M / I_M$
 V_M : Voltage measurement value
 I_M : Specified current

Hall IC for fan motor (LT202A)

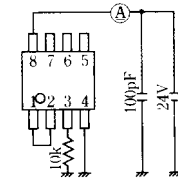
(a) output saturation voltage



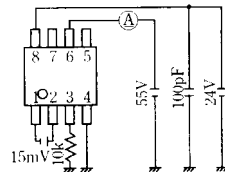
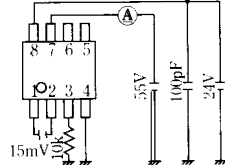
(b) Output cutoff current



(c) Power supply current

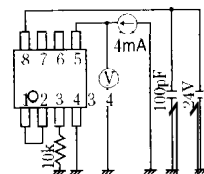


(d) Coil input sensitivity

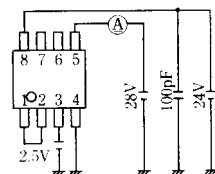


The Hall device measures coil input sensitivity by impressing the coil input current and verifying the output current condition

(e) Alarm output saturation voltage



(f) Alarm output leak current



General Description

3 Noncontact switch Hall ICS

< Unidirectional magnetic field-type: LT230A/253A/251A/280A >

(a) Operating magnetic flux densities B_{OP} and B_{RP} and hysteresis breadth B_H

⊙ B_{OP}

Minimum magnetic flux density when measurement circuit (c) sweeps the magnetic flux density from 10 mT to 30 mT and V_{OUT} becomes low level

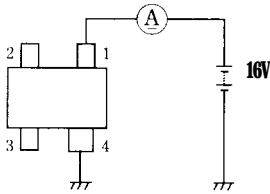
⊙ B_{RP}

Maximum magnetic flux density when measurement circuit (c) sweeps the magnetic flux density from 30 mT to 10 mT and V_{OUT} becomes high level.

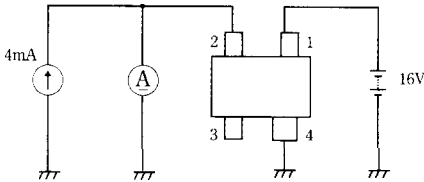
⊙ B_H

$$B_H = B_{OP} - B_{RP}$$

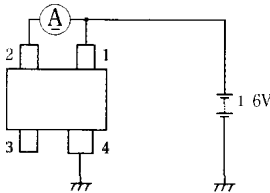
(b) Supply current I_{CC} ($V_{CC} = 16V^{*1}$, $B \geq 10mT$)



(c) L-level output voltage V_{OL} ($V_{CC} = 16V^{*1}$, $B \leq 30mT$)



(d) output leak current I_{OH} ($V_{CC} = 16V^{*1}$, $B \leq 10mT$)



$V_{CC} = 3V$ for LT280A

Notice: For all of the above circuits, the direction of the magnetic field is indicated as follows: When B is plus (+) value, the south pole (S) is impressed on the marking printed surface. When B is minus (-) value, the north pole (N) is impressed on the marking printed surface.

< Alternating magnetic field-type: LT260A/261A/262A >

(a) Operating magnetic flux densities B_{OP} and B_{RP} and hysteresis breadth B_H

⊙ B_{OP}

Minimum magnetic flux density when measurement circuit (c) sweeps magnetic flux density from -10 mT to 10 mT and V_{OUT} becomes low level.

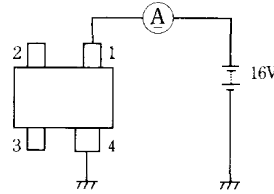
⊙ B_{RP}

Maximum magnetic flux density when measurement circuit (c) sweeps magnetic flux density from 10 mT to -10 mT and V_{OUT} becomes high level.

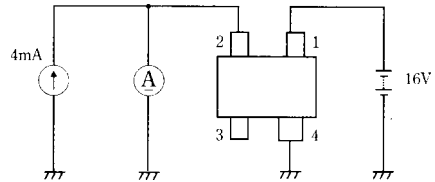
⊙ B_H

$$B_H = B_{OP} - B_{RP}$$

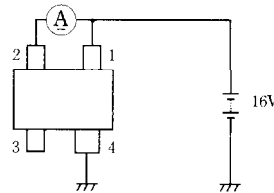
(b) Supply current I_{CC} ($V_{CC} = 16V^{*2}$, $B \leq -10mT$)



(c) L-level output voltage V_{OL} ($V_{CC} = 16V^{*2}$, $B = 10mT$)



(d) Output leak current I_{OH} ($V_{CC} = 16V^{*2}$, $B > -10mT$)



$*2 V_{CC} = 5V$ for LT262A

Notice: For all of the above circuits, the direction of the magnetic field is indicated as follows: When B is plus (+) value, the south pole (S) is impressed on the marking printed surface. When B is minus (-) value, the north pole (N) is impressed on the marking printed surface.